



Features

- 800 MHz Vortex86DX3TM CPU, 2 cores
- RAM: soldered DDR3-800 SDRAM, 2 GB
- Bus frequency: 500 MHz
- Built-in non-volatile memory: 8 KB FRAM for storing configuration
- FLASH BIOS: 2 MB, modifiable within the system
- Operating temperature range: -40°C...+85°C
- Shock / Vibration resistance: 50g / 5g
- Software compatibility: Microsoft™ MS-DOS®6.22, FreeDOS, Linux Debian 8, QNX 6.x, Microsoft™ Windows 7 Embedded, Windows Embedded Standard 2009
- Weight: no more than 100g
- MTBF: no less than 50 000 h

Overview

The x86 114 x 95 mm CPU Module in ETX format is designed for building highly reliable embedded energy-saving systems with compact overall dimensions.

Technical Specifications

CPU

- Vortex86DX3™, 2 cores
- Clock frequency: 800 MHz
- 32-bit x86 core
- 32 bit memory bus
- L1 cache (32 KB)
- L2 cache (512 KB)
- MMX, SSE extensions

RAM

- Soldered, DDR3-800 SDRAM, 2 GB
- $\bullet\,$ Bus frequency: 400 MHZ

Embedded Graphics Co-Processor

- 2D accelerator
- · Video memory capacity allocated from the main memory, up to 64 MB

Integrated HDA-compatible sound controller

Integrated non-volatile memory

- 8 KB FRAM for configuration storing
- With no battery, the CMOS settings are stored in FRAM (I2C)

FLASH BIOS

• 2 MB, modifiable within the system

Connector for MicroSD cards:

- · Support of SD, SDHC, speed class 6 cards
- Volume up to 32 GB

FLASH drive

- Soldered drive, 8 GB, drive controller is connected to SATA interface
- Memory type used NAND Flash (SLC)

I/O ports

- X1: 32-bit PCI bus, frequency: 33 MHz
- X1: connection of up to 4 devices USB 1.1/2.0 , support of booting from USB devices
- X1: linear stereo input/output, microphone input (mono)
- X2: 16-bit ISA bus 8/16 MHz
- X3: port for RGB display with the resolution of up to 1920x1440
- X3: port for LVDS panels with the resolution of up to 1920x1440
- X3: serial ports COM1 / COM2 (entire range of signals), compatibility with 16C550 / 16C552, exchange rate up to 3 Mbaud
- X3: PS/2 keyboard and mouse port
- · X3: universal parallel LPT port
- \bullet X4: HDD connection port, 1 Primary channel, connection of up to 2 devices, support of Ultra-DMA 100
- X4: LAN 10/100 Mb port
- X4: I2C, 100/400 Kb port
- X4: SMB port

- X4: "Speaker Out" port for buzzer connection
- X4: "RTC battery" port for battery power supply connection

Real Time Clock

(battery power supply is fed by the carrier-board)

Console ports

COM1 / COM2 / COM3

Digital Temperature Sensor

- Temperature measurement: from -55 to +125°C
- Resolution: 12 bit + sign
- Least significant digit value: 0.0625°C
- Conversion time: up to 1000 msec.

Watchdog Timer

• Programmable actuation interval: from 100 μs to 3 min

Software compatibility

- Microsoft™ MS-DOS®6.22, FreeDOS
- Linux Debian 8
- QNX 6.x
- Microsoft™ Windows 7 Embedded
- Windows Embedded Standard 2009

Power supply

- +4.75...+5.25 V
- +2.3...+3.3 V (battery power supply, used for the real time clock where the main power supply voltage is disabled)

Power consumption

• 6 W (5V @ 1.2A)

Operating temperature range

• -40°C ... + 85°C

Humidity

• up to 80% without the condensation

Shock / Vibration resistance

• 50g / 5g

MTBF

No less than 50 000 hours

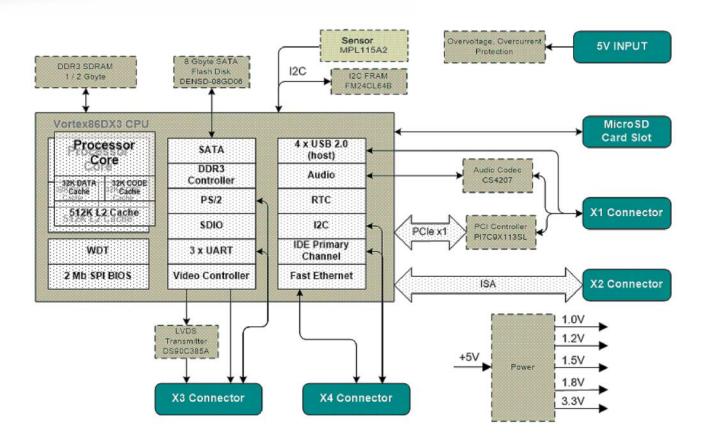
Dimensions:

• 114.0 × 95.0 × 14.0 mm

Weight

No more than 100 g

Connection Diagram



Ordering Information

CPB914 Configuration

CPB914 - 01 \Options

Configurations 01 CPB914 CPU Module, ETX format, Vortex86DX3 800 MHz 2 cores, 2 GB DDR3 SDRAM **Options**

Conformal coating

Delivery checklist

CPB914 delivery checklist contains:

- 1. CPB914 CPU Module
- 2. Packaging

Additional accessories

KIB1282-0 - Carrier-board for ETX modules

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Product specifications are subject to change without notice

Corporate Offices

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